NX5DV330

Quad 1-of-2 video multiplexer/demultiplexer

Rev. 03 — 5 August 2009

Product data sheet

1. General description

The NX5DV330 is a quad 1-of-2 high-speed TTL-compatible video multiplexer/demultiplexer. The low ON resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise

It has a digital select input (S), four independent inputs/outputs (nY0, nY1), a common input/output (nZ) and an active LOW enable input (\overline{E}) . When pin \overline{E} is HIGH, the switch is turned off.

Schmitt-trigger action at the enable input (\overline{E}) and select input (S) makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 4.0 V to 5.5 V.

The NX5DV330 is characterized for operation from -40 °C to +85 °C.

2. Features

- \blacksquare 5 Ω switch connection between two ports
- TTL-compatible input levels
- Minimal propagation delay through the switch
- ESD protection:
 - HBM JESD22-A114E Class 2A exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 1000 V
- Latch-up testing is done to JEDEC standard JESD78 which exceeds 100 mA



Quad 1-of-2 video multiplexer/demultiplexer

2 of 15

Ordering information

Table 1. **Ordering information**

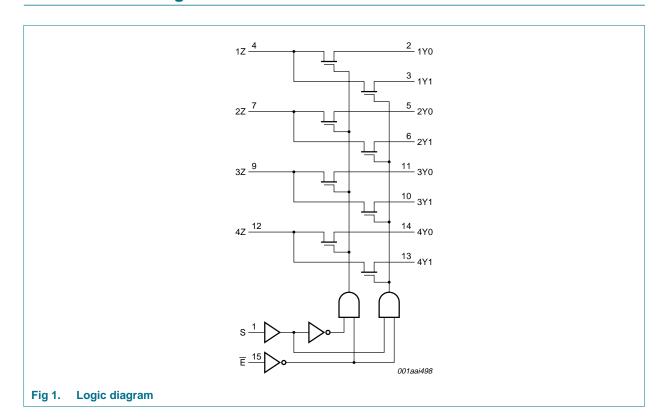
Type number	Package									
	Temperature range	Name	Description	Version						
NX5DV330D	–40 °C to +85 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						
NX5DV330DS	–40 °C to +85 °C	SSOP16[1]	plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT519-1						
NX5DV330PW	–40 °C to +85 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1						
NX5DV330BQ	–40 °C to +85 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5\times3.5\times0.85~\text{mm}$	SOT763-1						

^[1] Also known as QSOP16.

Product data sheet

Downloaded from **Elcodis.com** electronic components distributor

Functional diagram

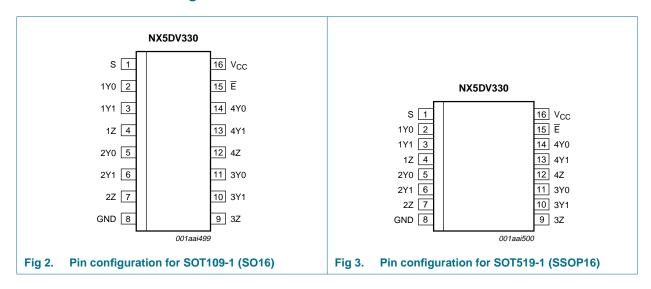


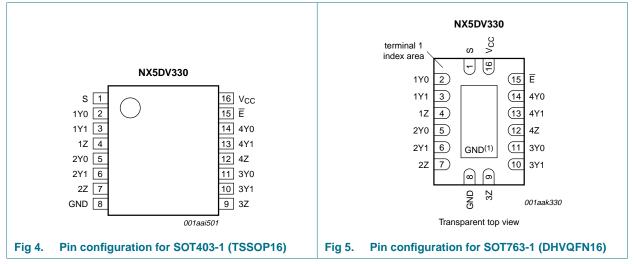
NX5DV330_3 © NXP B.V. 2009. All rights reserved. Rev. 03 — 5 August 2009

Quad 1-of-2 video multiplexer/demultiplexer

5. Pinning information

5.1 Pinning





5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description				
S	1	select control input				
1Y0, 1Y1, 2Y0, 2Y1, 3Y1, 3Y0, 4Y1, 4Y0	2, 3, 5, 6, 10, 11, 13, 14	independent input or output				
1Z, 2Z, 3Z, 4Z	4, 7, 9, 12	independent input or output				
GND	8	ground (0 V)				
Ē	15	enable input (active LOW)				
V _{CC}	16	positive supply voltage				

Quad 1-of-2 video multiplexer/demultiplexer

6. Functional description

Table 3. Function selection

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = Don't \ care.$

Input		Switch
Ē	s	
L	L	Y0 to Z or Z to Y0
L	Н	Y1 to Z or Z to Y1
Н	Χ	switch off

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7.0	V
V_{I}	input voltage		[<u>1]</u> -0.5	+7.0	V
I _{SW}	switch current	continuous current through each switch	-	128	mA
I _{IK}	input clamping current	V _I < 0 V	-	-50	mA
T _{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation		[2][3][4]	500	mW

^[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

8. Recommended operating conditions

Table 5. Operating conditions

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		4.0	5.0	5.5	V
V_{IH}	HIGH-level input voltage		2.0	-	-	V
V_{IL}	LOW-level input voltage		-	-	8.0	V
V_{H}	hysteresis voltage	pin S, E	-	45	-	mV
T _{amb}	ambient temperature	operating in free-air	-40	+25	+85	°C

^[2] For SO16 package: Ptot derates linearly with 8 mW/K above 70 °C.

^[3] For SSOP16 (QSOP16) and TSSOP16 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

^[4] For DHVQFN16 packages: above 60 °C derate linearly with 4.5 mW/K.

Quad 1-of-2 video multiplexer/demultiplexer

9. Static characteristics

Table 6. Static characteristics

 $T_{amb} = -40 \,^{\circ}\text{C}$ to +85 $^{\circ}\text{C}$.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
V_{IK}	input clamping voltage	$V_{CC} = 4.5 \text{ V}; I_{I} = -18 \text{ mA}$	-	-	-1.2	V
II	input leakage current	pin S, \overline{E} ; V _{CC} = 5.5 V; V _I = GND or 5.5 V	-	-	±1	μΑ
I _{S(OFF)}	OFF-state leakage current	$V_{CC} = 5.5 \text{ V}; V_I = \text{GND}; V_O = 0 \text{ V to } 5.5 \text{ V}$	-	-	±1	μΑ
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} = V_{O} = 0 \text{ V to } 5.5 \text{ V}$	-	-	±1	μΑ
I _{CC}	supply current	V_{CC} = 5.5 V; I_{O} = 0 mA; V_{I} = V_{CC} or GND	-	-	3	μΑ
ΔI_{CC}	additional supply current	pin S, \overline{E} ; V _{CC} = 5.5 V; one input at 3.4 V, other inputs at V _{CC} or GND	[2] _	-	2.5	mA
Cı	input capacitance	pin S, \overline{E} ; V _I = 5 V or 0 V	-	3.5	-	pF
C _{io(off)}	off-state input/output	Z port; $V_{CC} = 5 \text{ V}$; $V_O = 5 \text{ V}$ or 0 V ; $\overline{E} = V_{CC}$	-	6.0	-	pF
	capacitance	Y port; $V_{CC} = 5 \text{ V}$; $V_{O} = 5 \text{ V}$ or 0 V ; $\overline{E} = V_{CC}$	-	4.0	-	pF
C _{io(on)}	on-state input/output capacitance	Z port; $V_{CC} = 5 \text{ V}$; $V_O = 5 \text{ V}$ or 0 V ; $\overline{E} = GND$	-	14	-	pF
R _{ON}	ON resistance	V _{CC} = 4.5 V	[3]			
		V _I = 1.0 V; I _I = 13 mA	-	3	7	Ω
		$V_1 = 2.0 \text{ V}; I_1 = 26 \text{ mA}$	-	7	10	Ω

^[1] All typical values are measured at V_{CC} = 5 V; T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $T_{amb} = -40 \,^{\circ}C$ to +85 $^{\circ}C$; for test circuit see Figure 7.

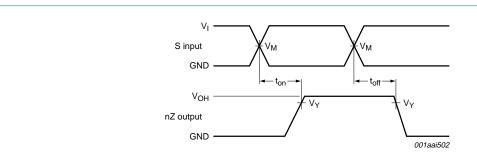
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{on}	turn-on time	S to nZ; see Figure 6				
		V _{CC} = 4.5 V to 5.5 V	-	4.0	6.0	ns
t _{off}	off turn-off time	S to nZ; see Figure 6				
		V _{CC} = 4.5 V to 5.5 V	-	2.3	6.0	ns

^[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

^[3] Measured by the voltage drop between the Z and the Y terminals at the indicated current through the switch. ON-state resistance is determined by the lowest voltage of the two (Z or Y) terminals.

Quad 1-of-2 video multiplexer/demultiplexer

11. Waveforms



Measurement points are given in Table 8.

 V_{OH} is the typical voltage output level that occurs with the output load.

Fig 6. Input (S) to output (nZ) turn-on and turn-off time

Table 8. Measurement points

Supply voltage	Input		Output
V _{CC}	VI	V _M	V _Y
4.5 V to 5.5 V	GND to 3.0 V	1.5 V	0.9V _{OH}

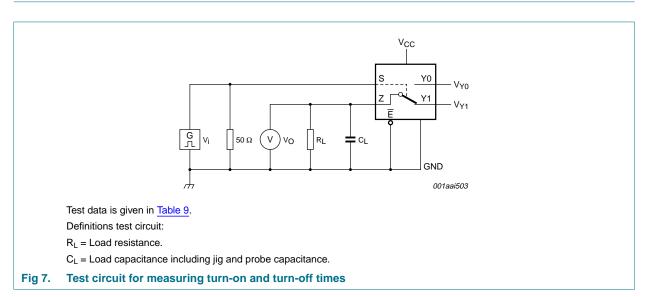


Table 9. Test data

Input		Load				
VI	fi	t _r , t _f	V _{Y0}	V _{Y1}	R _L	CL
GND to 3.0 V	≤ 10 MHz	≤ 2.5 ns	GND to 3.0 V	3.0 V to GND	75 Ω	20 pF

Quad 1-of-2 video multiplexer/demultiplexer

12. Additional dynamic characteristics

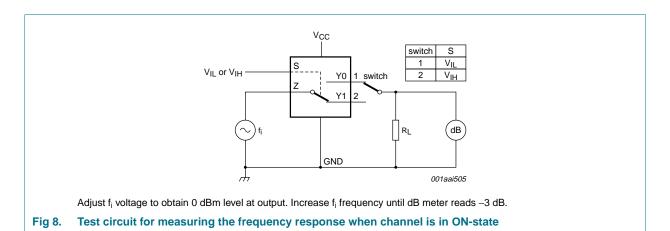
Table 10. Additional dynamic characteristics

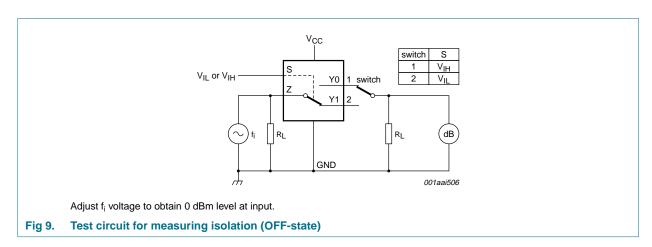
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); V_I = GND or V_{CC} (unless otherwise specified); T_{amb} = 25 °C; V_{CC} = 4.5 V to 5.5 V.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
G_{dif}	differential gain	$f_i = 3.58 \text{ MHz}; R_L = 150 \Omega$	-	0.64	-	%
φ _{dif}	differential phase	$f_i = 3.58 \text{ MHz}; R_L = 150 \Omega$	-	0.1	-	deg
$f_{(-3dB)}$	-3 dB frequency response	$R_L = 150 \Omega$; see Figure 8	300	-	-	MHz
α_{iso}	isolation (OFF-state)	f_i = 10 MHz; R_L = 150 Ω ; see Figure 9	-	-60	-	dB
Xtalk	crosstalk	between switches; see Figure 10; f_i = 10 MHz; R_L = 150 Ω ; R_i = 10 Ω	1] -	-63	-	dB

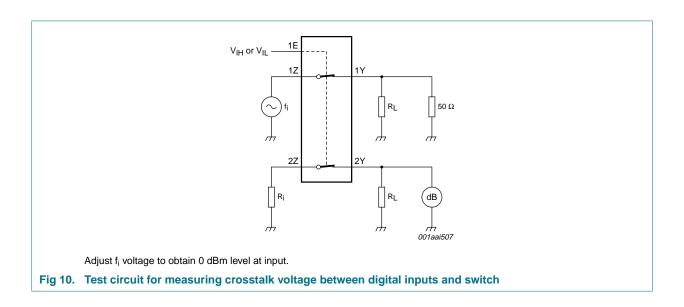
^[1] All unused analog input pins (nZ) and outputs pins (nYn) are connected through 10 Ω and 50 Ω pull-down resistors, respectively.

13. Test circuits





Quad 1-of-2 video multiplexer/demultiplexer



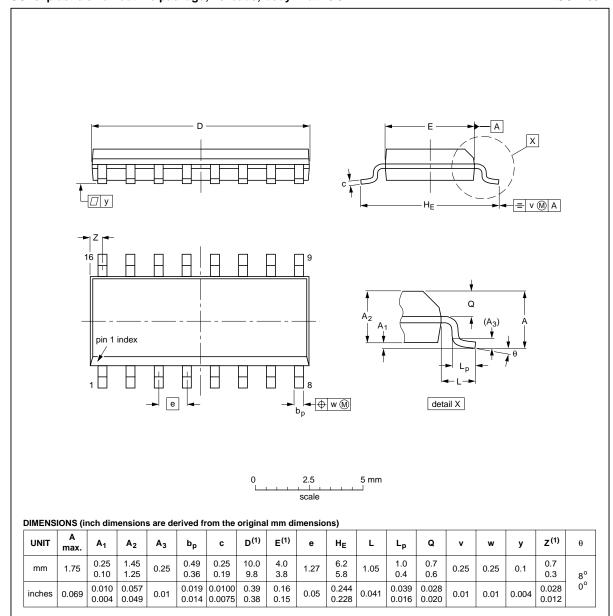
Product data sheet

Quad 1-of-2 video multiplexer/demultiplexer

14. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

		EUROPEAN	ISSUE DATE		
IEC	JEDEC	JEITA		PROJECTION	1330E DATE
076E07	MS-012				99-12-27 03-02-19
0					TEC JEDEC JEHA

Fig 11. Package outline SOT109-1 (SO16)

Quad 1-of-2 video multiplexer/demultiplexer

SSOP16: plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm SOT519-1

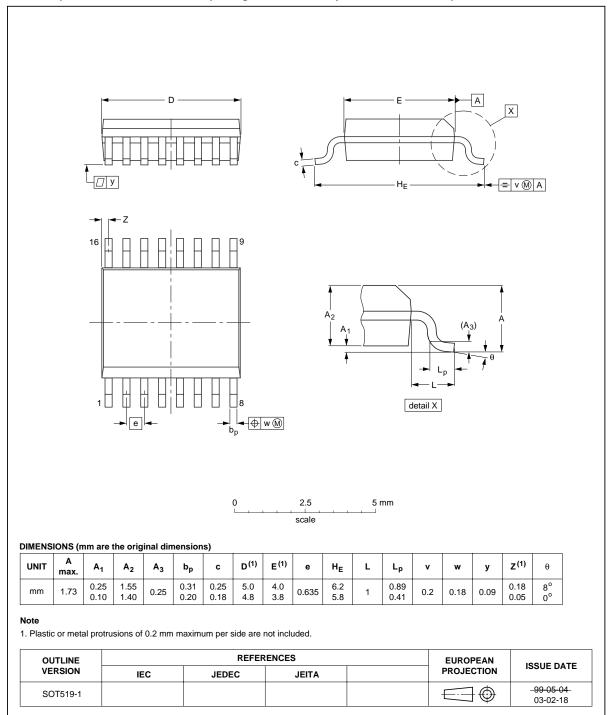
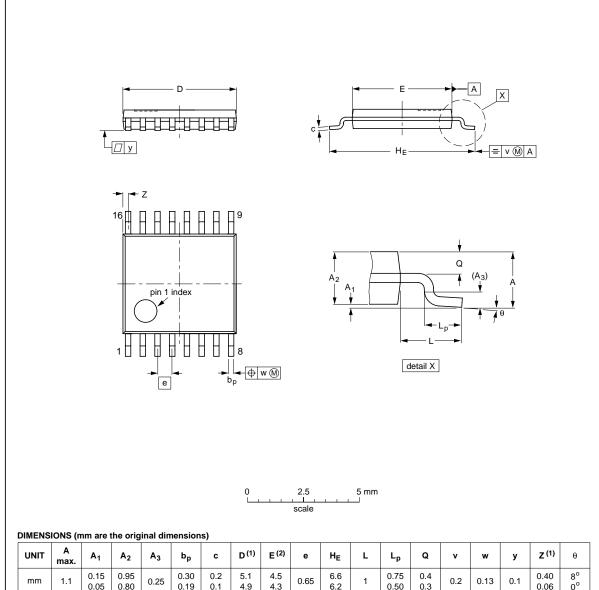


Fig 12. Package outline SOT519-1 (SSOP16)

Quad 1-of-2 video multiplexer/demultiplexer

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ	
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°	

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE	
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				99-12-27 03-02-18

Fig 13. Package outline SOT403-1 (TSSOP16)

Quad 1-of-2 video multiplexer/demultiplexer

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

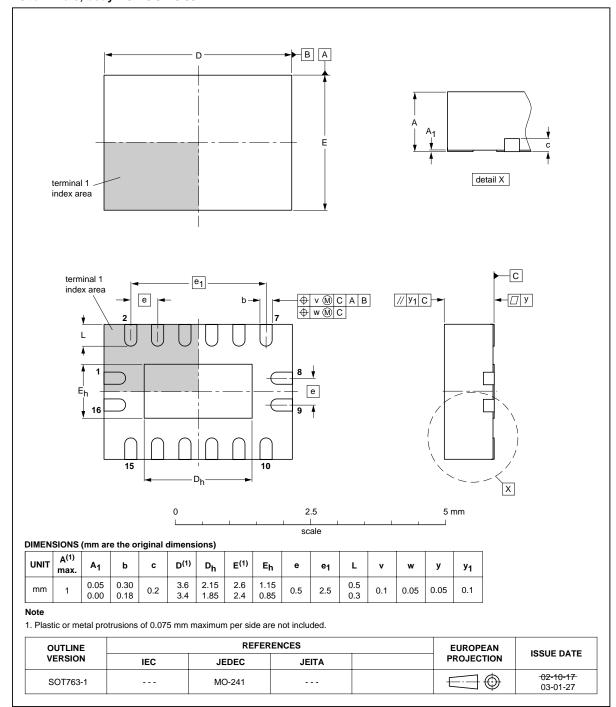


Fig 14. Package outline SOT763-1 (DHVQFN16)

Quad 1-of-2 video multiplexer/demultiplexer

15. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

16. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX5DV330_3	20090805	Product data sheet	-	NX5DV330_2
Modifications:	 Added type no 	umber NX5DV330BQ (DHVQF	N16 package)	
NX5DV330_2	20080825	Product data sheet	-	NX5DV330_1
NX5DV330_1	20080815	Product data sheet	-	-

Quad 1-of-2 video multiplexer/demultiplexer

17. Legal information

17.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

17.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

17.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

17.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

18. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

Quad 1-of-2 video multiplexer/demultiplexer

19. Contents

1	General description	1
2	Features	1
3	Ordering information	2
4	Functional diagram	2
5	Pinning information	3
5.1	Pinning	3
5.2	Pin description	3
6	Functional description	4
7	Limiting values	4
8	Recommended operating conditions	4
9	Static characteristics	5
10	Dynamic characteristics	5
11	Waveforms	6
12	Additional dynamic characteristics	7
13	Test circuits	7
14	Package outline	9
15	Abbreviations 1	3
16	Revision history 1	3
17	Legal information 1	4
17.1	Data sheet status	4
17.2	Definitions 1	
17.3	Disclaimers	4
17.4	Trademarks1	4
18	Contact information 1	4
19	Contents	5

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2009.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 5 August 2009 Document identifier: NX5DV330_3

